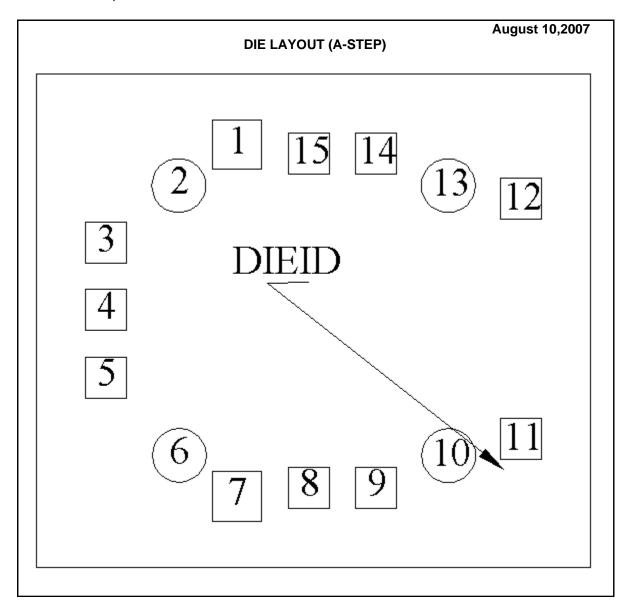


LP3984I-1.5 MDC MWC MICROPOWER, 150MA ULTRA LOW-DROPOUT CMOS VOLTAGE REGULATOR



DIE/WAFER CHARACTERISTICS

Fabrication Attributes		General Die Information			
Physical Die Identification	LP3984A-1.5	Bond Pad Opening Size (min)	92μm x 92μm		
Die Step	А	Bond Pad Metalization	0.5%COPPER_BAL. ALUMINUM		
Physical Attributes		Passivation	PECVDOX+NITRIDE		
Wafer Diameter	200mm	Back Side Metal	BARE BACK		
Die Size (Drawn)	$1029\mu m \ x \ 914\mu m$ 40.5mils x 36.0mils	Back Side Connection	GND		
Thickness	254µm Nominal				
Min Pitch	107μm Nominal				

Special Assembly Requirements:

Note: Actual die size is rounded to the nearest micron.



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or Over, 150	Die Bond Pad				ULAI		
(Rafaranca)			,		II – Na	t Head	
SIGNAL	PAD#	inates in μm) NC = No Connection X/Y COORDINATES			PAD SIZE		
NAME	NUMBER	X	Y	Х	170	<u> </u>	
VIN	1	-142	326	92	х	92	
V_{IN}	2	-250	250	100	Х	100	
NC	3	-385	144	76	Χ	76	
NC	4	-385	19	76	X	76	
NC	5	-385	-106	76	X	76	
V_{OUT}	6	-250	-250	100	Х	100	
V_{OUT}	7	-142	-326	92	Х	92	
NC	8	-9	-310	76	X	76	
NC	9	116	-310	76	X	76	
GND	10	250	-250	100	Х	100	
NC	11	385	-220	76	X	76	
NC	12	385	225	76	X	76	
V_{EN}	13	250	250	100	Х	100	
NC	14	116	310	76	X	76	
NC	15	-9	310	76	X	76	



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Notes							
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sustain life and whose failure to can be reasonably expected to	o result in a significant injury to se failure to perform can be rea	in accordance with instruction the user. A critical componen	is for use provided in the labeling				
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